

Features

- Low voltage operation
- Low current consumption
- Miniature SMD package size
- I²C communication protocol
- Reliable capacitive technology
- Relative humidity accuracy of ±2 % (Typical)

Applications

Industrial:

- HVAC systems
- Process monitoring
- Packaging automation
- **Medical Devices (low/medium risk):
- Diagnostic equipment
- Analysis equipment

BPS230 Series - 2 mm Humidity Sensor

Absolute Maximum Ratings	
Supply Voltage (V _{cc})nput Voltage (V _I)	-0.3 to 7.0
CE	0.3 to V _{cc} + 0.3
SCL/SDA	
Output Voltage (VO)	0.3 to V _{cc} + 0.3
i-level Output Current (IOH)	
1 Terminal	
All Terminals Total	20 m
ow-level Output Current (IOL)	<u>_</u>
1 Terminal	
All Terminals Total	
Operating Temperature (T _a)	-40°C to +105°C (-40°F to +221°F
torage Temperature (T _{stg})	50 C t0 +125 C (-56 F t0 +257 F
Recommended Operating Conditions	
ower Supply Voltage (V _{cc})	
apacitance between V_{cc} and V_{ss} (C_p)	
ull Up Resistor Value on SDA ¹ (R1)	
ull Up Resistor Value on SCL1 (R2)	5 kΩ typic
Select the resistance value to meet AC characteristics.	
Electrical Characteristics	
umidity Detection	
Measurement Range	0 to 100 % R
Resolution (10-bit)	0.1 % RH typic
Humidity Accuracy - Typical (see Humidity Sensor Accuracy Graph for Maximum Rating)	
@ 25 °C (20 to 80 % RH)	
@ 5 °C to 45 °C (0 to 100 % RH)	
Hysteresis @ 5 °C to 45 °C (0 to 100 % RH)	±1 % RH typica
Response Time	•
Reach (τ 63 % @ 25 °C, wind velocity @ 1.0 m/s)	8 second
Inless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -20 °C to 100 °C	
emperature Detection	
Measurement Range	30 °C to +100 °C (-22 °F to +212 °F
Resolution (11 bit)	
-10 °C to +70 °C	
All other temperatures	0.4 °C (0.72 °F
Temperature Accuracy	0.4.00 / 0.70.00
@ 5 °C to 60 °C	
@ -20 °C to 85 °C Reproducibility @ -30 °C to 100 °C	
Response Time	± 0.1 C (±0.16 F
Reach (τ 63 % (dependent on surrounding heat conduction NOTE 1)	
Inless otherwise specified: V162 to 55 V V0 V T - 20 °C to 100 °C	
Inless otherwise specified: $V_{CC} = 1.62$ to 5.5 V, $V_{SS} = 0$ V, $T_a = -30$ °C to 100 °C	
NOTE 1 Extended exposure to >90 % RH causes a shift of up to 3 % RH which is reversible after	a period of 14 days.
Current Consumption	
leep Current (CE=0, Sleep Mode)	10 nA typical 400 nA maximu

Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = 0 °C to 60 °C

- RoHS3 Directive 2015/863 Amendments of Annex II on March 31, 2015
- Bourns® products have not been designed for and are not intended for use in "lifesaving," "life-critical" or "life-sustaining" applications nor any other applications where failure or malfunction of the Bourns® product may result in personal injury or death. See Legal Disclaimer Notice on the last page of this document. Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

The products described herein and this document are subject to specific legal disclaimers as set forth on the last page of this

BOURNS

Input/Output Terminal Characteristics

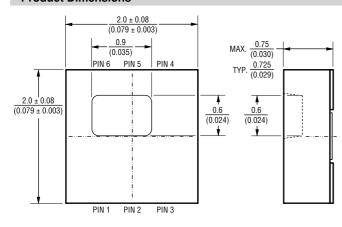
High Level Input Voltage 1 (VIH1) [Target Terminal: SCL, SDA]	
High Level Input Voltage 2 (VIH2) [Target Terminal: CE]	
Low Level Input Voltage 1 (VIL1) [Target Terminal: SCL, SDA]	V _{ss} minimum, 0.3 V _{cc} maximum
Low Level Input Voltage 2 (VIL2) [Target Terminal: CE]	V _{ss} minimum, 0.2 V _{cc} maximum
Low Level Output Current (IOL) [VOL = 0.1 V _{CC} , Target Terminal: SCL, SDA]	
Terminal Leak Current 1 (IL1) [Terminal voltage = V _{CC} , Target Terminal: SCL, SDA]	± 1 μA
Terminal Leak Current 2 (IL2) [Terminal voltage = 0 V, Target Terminal: SCL, SDA, CE]	± 1 μA
Input Pull-Down Resistance (RPD) [Terminal voltage = V _{CC} , Target Terminal: CE]60	0 kΩ minimum, 150 kΩ typical, 450 kΩ maximum

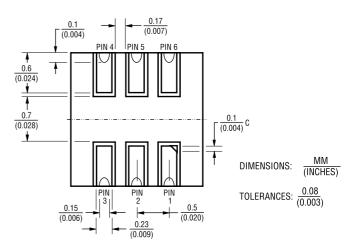
Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -30 °C to 100 °C

Product Characteristics

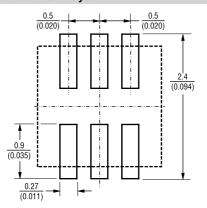
Moisture Sensitivity Level	1
ESD Classification (HBM)	
Marking	
Standard Packaging	
Weight	, , , , , , , , , , , , , , , , , , ,

Product Dimensions





Recommended PCB Layout



Terminal Assignment

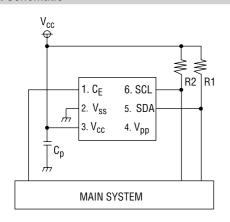
No.	Terminal Name	Function
1	CE	Chip enable terminal
2	V_{ss}	Power supply terminal (-)
3	V_{cc}	Power supply terminal (+)
4	NC	No connection
5	SDA	I ² C serial data
6	SCL	I ² C serial clock

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

BOURNS®

Basic Circuit Schematic



 C_p $0.1 \mu F$ R1 $5k \Omega$ R2 $5k \Omega$

NOTE: R1 and R2 are reference values. Resistor values should be selected to meet the AC characteristics.

Operation Mode

Operation	Terminal Setup	Operation State of Each Functional Block						
Mode	CE	V _{pp}	Power Supply	Oscillation	Temp. Detection	Capacitance Detection	OTP Memory	I ² C-Bus
Sleep *1	0	NC	Stop	Stop	Stop	Stop	Stop	Stop
Standby	1	NC	Operation	Operation	Stop	Stop	Read-out Possible	Operation

^{*1} In case of power control mode, there is no sleep operation. I²C slave address (SADR) is defined as "111 1111" (7Fh).

Control Register Map

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.			
	D7-1	-	Reserved	-			R	0			
00h	D0 RESET	D0 RESET Rese	D0 RESET Reset	Reset	0	Normal Operation	None	R/W	0		
				1	-	Reset Action					
	D7-6	MANMODE	Manual Detection Mode	00	Normal Operation Mode						
	D5-3	B HAVE[2:0]	Humidity Detection Value Avg.	000	No Averaging Process		B/W	0			
				001	2 Times Average Mode	erage Mode					
01h	D5-3			01x	4 Times Average Mode						
		Mode 1xx 8 Times Ave		erage Mode							
						Temperature	0	8 Times Av	erage Mode		
	D2 TAVE Detection Value Avg. Mode	1	16 Times Av	verage Mode	R/W	0					

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

Control Register Map (Continued)

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.
	D1	-	Reserved	-			R	0
01h	DO MAN	MAN	Manual Detection	0	Standby State	Detection Operation Stop	B/W	0
	D0	IVIAIN	Mode	1	Under Detection Operation	Detection Operation Start	17/ VV	
	D7-1	-	Reserved	-			R	0
03h	Do	FDD	Manual	0	No Error	Nothing is Done	DAA	•
	D0	ERR	Detection Error Flag	1	Error Occurred	Error Flag Reset	R/W	0
04h	D7-0	HC[7:0]	Humidity Detection Result (After Correction Operation)		000h-3FFh		R	Х
	D7-2	-	Reserved	-			R	0
05h	D1-0	HC[9:8]	Humidity Detection Result (After Correction Operation)				R	х
06h	D7-0	TC[7:0]	Temperature Detection Result (After Correction Operation)		000h-7FFh		R	Х
	D7-3	-	Reserved	-			R	0
07h	D2-0	TC[10:8]	Temperature Detection Result (After Correction Operation)				R	Х
0Ah	D7-0	K[7:0]	Capacity Detection Result (Before Correction Operation)		000h-FFFFh		R	0

Specifications are subject to change without notice.
Users should verify actual device performance in their specific applications.
The products described herein and this document are subject to specific legal disclaimers as set forth on the last page of this document, and at www.bourns.com/docs/legal/disclaimer.pdf.

BOURNS®

Control Register Map (Continued)

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.
0Bh	D7-0	K[15:8]	Capacity Detection Result (Before Correction Operation)				R	0
	D7-5	-	Reserved	-		-	R	0
			Standard	0	Outside Capacity Cutting			
2Ch	D4 SCR_ON_R	Capacity Connection Control	1	Outside Capacity Connection		R/W	0	
	D3-0	SCI_ ON_R[3:0]	Internal Capacity Connection Control	At ·	0h~Fh x 0.6 pF Example: At the time of 8 hours, ess to internal capacity of 4.8 pF		R/W	Х
	D7-1	-	Reserved	-	-		R	0
03h	D0 ERR Detection Error Flag		0	No Error	Nothing is Done	5.44		
				Error Occurred	Error Flag Reset	R/W	0	

Transfer Function Formula

Humidity

RH = $\frac{100}{2^{10}}$ x RH_{IC} (0 ~ 100 % RH)

RH_{IC}: IC Humidity Output Data (10 bit)

Refer to Register Map:

 RH_{IC} = Data of the addresses 04H and 05H (000h ~ 3FFh) It changes into a decimal and is operation.

Temperature

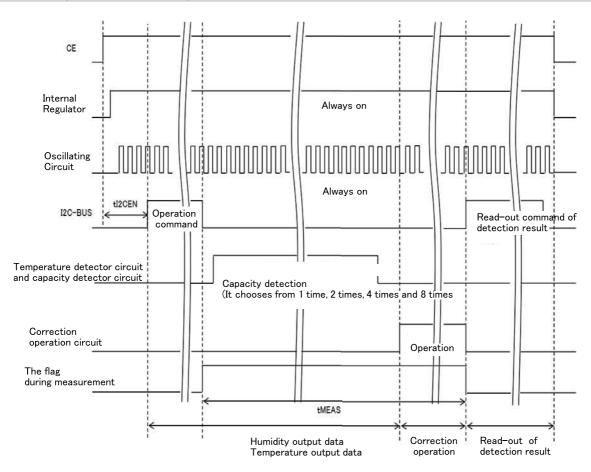
T = $[T_{IC} - (2^{10} - \frac{25}{0.1})] \times 0.1$ (-30 ~ 100 °C)

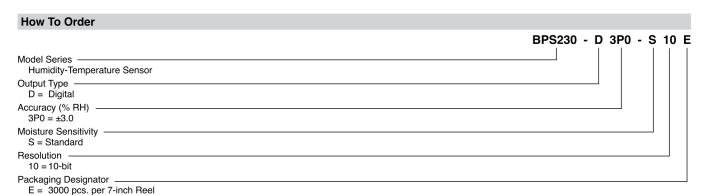
T_{IC}: IC Temperature Output Data (11 bit)

Refer to Register Map:

 T_{IC} = Data of the addresses 06H and 07H (000h ~ 7FFh) It changes into a decimal and is operation.

Capacitance/Temperature Detection Sequence



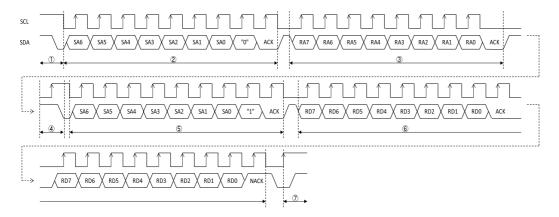


Specifications are subject to change without notice. Users should verify actual device performance in their specific applications.

Output Type Waveform and Data Read/Write Procedure

I²C-BUS Data Read-out Procedure

- (1) I²C master device releases START condition.
- (2) I²C master device transmits slave address and WRITE mode selection.
- (3) I²C master device transmits register address of this IC.
- $\stackrel{\textstyle ullet}{4}$ I 2 C master device releases repeated START condition. (Release method is same as START condition.)
- (5) I²C master device again transmits slave address and READ mode selection. (Read mode can be selected by transmitting "1" in 8th bit.)
- 6 I²C master device reads-out data from register address designated at ③.
 It is possible to read-out data while register address increments one, by reading-out multiple data continuously. However, during continuous read-out, please return ACK to this IC as a reply of master.
- (7) After the completion of all read-out, I²C master device releases STOP condition.



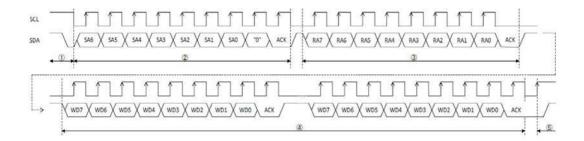
~ Continued ~

Output Type Waveform and Data Read/Write Procedure (Continued)

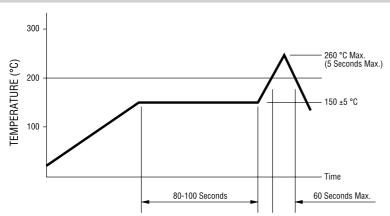
I²C-BUS Data Write-in Procedure

- (1) I²C master device releases START condition. (Start condition can be released by changing SDA from "H" to "L" while SCL is in "H" state.)
- (2) I²C master device transmits slave address and WRITE mode selection. (Write mode can be selected by transmitting "0" in 8th bit while 1~7th bits are slave address.)
- (3) I²C master device transmits register address of this IC.
- (4) I²C master device transmits write-in data.
- (5) It is possible to write-in data while register address increments one, by transmitting multiple write-in data continuously.

After the completion of transmitting all write-in data, I²C master device releases stop condition. (Stop condition can be released by changing SDA from "L" to "H" while SCL is in "H" state.)



Solder Profile



Processing Method: Reflow soldering with infrared heat or forced air convection (only once).

Notes:

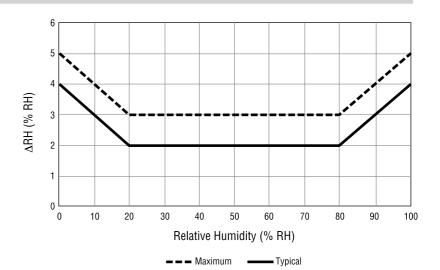
- 1. No clean solder paste is recommended.
- 2. Aqueous wash is not recommended.
- Use of water soluble soldering flux should be avoided due to possible corrosion.
- 4. Multiple passes through the soldering process is not recommended.
- 5. Other SMD processes and profiles should be verified by the customer.

Specifications are subject to change without notice.

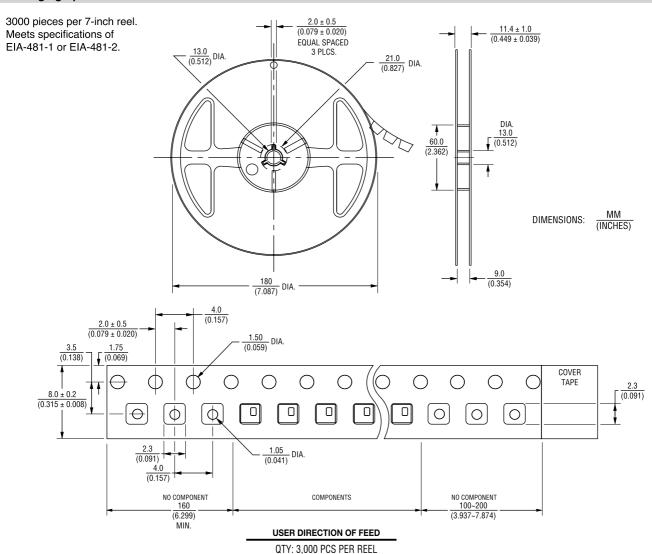
Users should verify actual device performance in their specific applications.

Humidity Sensor Accuracy

Relative Humidity (% RH)	Maximum	Typical
0	5	4
10	4	3
20	3	2
30	3	2
40	3	2
50	3	2
60	3	2
70	3	2
80	3	2
90	4	3
100	5	4



Packaging Specification



BOURNS®

Asia-Pacific: Tel: +886-2 2562-4117 • Email: asiacus@bourns.com

EMEA: Tel: +36 88 885 877 • Email: eurocus@bourns.com

The Americas: Tel: +1-951 781-5500 • Email: americus@bourns.com

www.bourns.com

REV. 07/19

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

Legal Disclaimer Notice

BOURNS

This legal disclaimer applies to purchasers and users of Bourns® products manufactured by or on behalf of Bourns, Inc. and its affiliates (collectively, "Bourns").

Unless otherwise expressly indicated in writing, Bourns® products and data sheets relating thereto are subject to change without notice. Users should check for and obtain the latest relevant information and verify that such information is current and complete before placing orders for Bourns® products.

The characteristics and parameters of a Bourns® product set forth in its data sheet are based on laboratory conditions, and statements regarding the suitability of products for certain types of applications are based on Bourns' knowledge of typical requirements in generic applications. The characteristics and parameters of a Bourns® product in a user application may vary from the data sheet characteristics and parameters due to (i) the combination of the Bourns® product with other components in the user's application, or (ii) the environment of the user application itself. The characteristics and parameters of a Bourns® product also can and do vary in different applications and actual performance may vary over time. Users should always verify the actual performance of the Bourns® product in their specific devices and applications, and make their own independent judgments regarding the amount of additional test margin to design into their device or application to compensate for differences between laboratory and real world conditions.

Unless Bourns has explicitly designated an individual Bourns® product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949) or a particular qualification (e.g., UL listed or recognized), Bourns is not responsible for any failure of an individual Bourns® product to meet the requirements of such industry standard or particular qualification. Users of Bourns® products are responsible for ensuring compliance with safety-related requirements and standards applicable to their devices or applications.

Bourns® products are not recommended, authorized or intended for use in nuclear, lifesaving, life-critical or life-sustaining applications, nor in any other applications where failure or malfunction may result in personal injury, death, or severe property or environmental damage. Unless expressly and specifically approved in writing by two authorized Bourns representatives on a case-by-case basis, use of any Bourns® products in such unauthorized applications might not be safe and thus is at the user's sole risk. Life-critical applications include devices identified by the U.S. Food and Drug Administration as Class III devices and generally equivalent classifications outside of the United States.

Bourns expressly identifies those Bourns® standard products that are suitable for use in automotive applications on such products' data sheets in the section entitled "Applications." Unless expressly and specifically approved in writing by two authorized Bourns representatives on a case-by-case basis, use of any other Bourns® standard products in an automotive application might not be safe and thus is not recommended, authorized or intended and is at the user's sole risk. If Bourns expressly identifies a sub-category of automotive application in the data sheet for its standard products (such as infotainment or lighting), such identification means that Bourns has reviewed its standard product and has determined that if such Bourns® standard product is considered for potential use in automotive applications, it should only be used in such sub-category of automotive applications. Any reference to Bourns® standard product in the data sheet as compliant with the AEC-Q standard or "automotive grade" does not by itself mean that Bourns has approved such product for use in an automotive application.

Bourns® standard products are not tested to comply with United States Federal Aviation Administration standards generally or any other generally equivalent governmental organization standard applicable to products designed or manufactured for use in aircraft or space applications. Bourns expressly identifies Bourns® standard products that are suitable for use in aircraft or space applications on such products' data sheets in the section entitled "Applications." Unless expressly and specifically approved in writing by two authorized Bourns representatives on a case-by-case basis, use of any other Bourns® standard product in an aircraft or space application might not be safe and thus is not recommended, authorized or intended and is at the user's sole risk.

The use and level of testing applicable to Bourns® custom products shall be negotiated on a case-by-case basis by Bourns and the user for which such Bourns® custom products are specially designed. Absent a written agreement between Bourns and the user regarding the use and level of such testing, the above provisions applicable to Bourns® standard products shall also apply to such Bourns® custom products.

Users shall not sell, transfer, export or re-export any Bourns® products or technology for use in activities which involve the design, development, production, use or stockpiling of nuclear, chemical or biological weapons or missiles, nor shall they use Bourns® products or technology in any facility which engages in activities relating to such devices. The foregoing restrictions apply to all uses and applications that violate national or international prohibitions, including embargos or international regulations. Further, Bourns® products and Bourns technology and technical data may not under any circumstance be exported or re-exported to countries subject to international sanctions or embargoes. Bourns® products may not, without prior authorization from Bourns and/or the U.S. Government, be resold, transferred, or re-exported to any party not eligible to receive U.S. commodities, software, and technical data.

To the maximum extent permitted by applicable law, Bourns disclaims (i) any and all liability for special, punitive, consequential, incidental or indirect damages or lost revenues or lost profits, and (ii) any and all implied warranties, including implied warranties of fitness for particular purpose, non-infringement and merchantability.

For your convenience, copies of this Legal Disclaimer Notice with German, Spanish, Japanese, Traditional Chinese and Simplified Chinese bilingual versions are available at:

Web Page: http://www.bourns.com/legal/disclaimers-terms-and-policies

PDF: http://www.bourns.com/docs/Legal/disclaimer.pdf